

LAI WEI

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EDUCATION

School of Robotics, Wuhan University

B.E. in Robotics Engineering

- GPA: 3.68/4.00, 88/100.

Hubei, China

2024 – 2028 (*expected*)

PUBLICATIONS

1. Z. Zhu, Z. Xia, Y. Hou, W. Cao, X. Sun, C. Li, Q. Ding, W. Zhou, Z. Jiang, H. Tang, L. Wei, C. Lei, and Z. Wang, “A high-performance wearable thermoelectric device with epoxy resin/pa/aln composite heat sink,” **Journal of Materials Chemistry A**, Feb. 2026, ISSN: 2050-7496. doi: 10.1039/D5TA07253K. [Online]. Available: <https://pubs.rsc.org/en/content/articlelanding/2026/ta/d5ta07253k>

PROJECTS

Thermoelectric-Based Airflow Sensing and Convective Heat Transfer Modeling

Undergraduate Research Project

2025.04 – Present

AWARDS AND HONORS

- **Provincial Third Prize**, Engineering Practice Competition (2025). 2025.03
Core Team Member Developed a vision-guided robotic sorting system for household waste classification.

LANGUAGES

- **Chinese:** Native.
- **English:** IELTS: 7.0 (CEFR C1, Jan 2026).

SKILLS

- **Programming:** Python, C/C++, R, MATLAB.
- **Robotics & Hardware:** PyTorch, STM32, Arduino, ESP32, PCB Design.
- **Simulation & Tools:** SolidWorks, COMSOL Multiphysics, AutoCAD.
- **Web & Others:** HTML/CSS, Git, Linux, Astro (Personal Blog).